

# OCMOS FET PS7142-1A,PS7142L-1A

## 6-PIN DIP, 400 V BREAK DOWN VOLTAGE

NORMALLY OPEN TYPE

-NEPOC Series-

**Solid State Relay** 

## 1-ch Optical Coupled MOS FET

## DESCRIPTION

The PS7142-1A and PS7142L-1A are solid state relays containing GaAs LEDs on the light emitting side (input side) and MOS FETs on the output side.

They are suitable for analog signal control because of their low offset and high linearity. The PS7142L-1A has a surface mount type lead.

#### FEATURES

- 1 channel type (1 a output)
- Low LED operating current (IF = 2 mA)
- Designed for AC/DC switching line changer
- Small package (6-pin DIP)
- Low offset voltage
- Ordering number of taping product : PS7142L-1A-E3, E4: 1 000 pcs/reel

#### <R> • Pb-Free product

- Safety standards
  - UL approved: File No. E72422
  - BSI approved: No. 8245/8246
  - CSA approved: No. CA 101391

#### APPLICATIONS

- Exchange equipment
- Measurement equipment
- FA/OA equipment

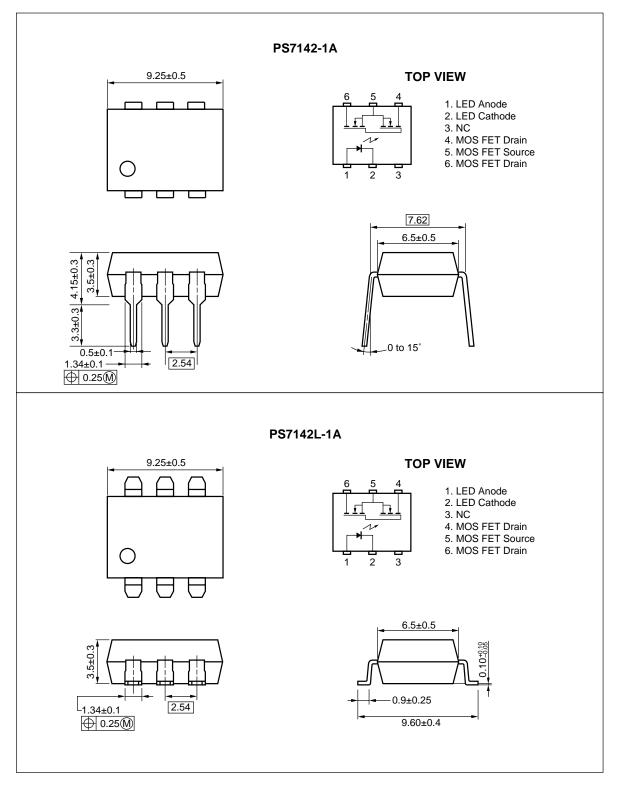
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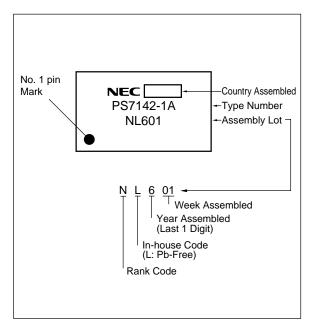
The mark <R> shows major revised points.

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

## PACKAGE DIMENSIONS (in millimeters)



## <R> MARKING EXAMPLE



## <R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number*1
PS7142-1A	PS7142-1A-A	Pb-Free	Magazine case 50 pcs	Standard products	PS7142-1A
PS7142L-1A	PS7142L-1A-A			(UL, BSI, CSA	
PS7142L-1A-E3	PS7142L-1A-E3-A		Embossed Tape 1 000 pcs/reel	approved)	
PS7142L-1A-E4	PS7142L-1A-E4-A				

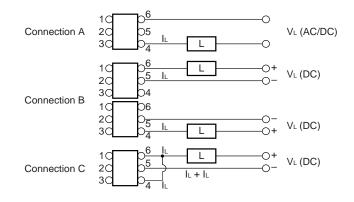
\*1 For the application of the Safety Standard, following part number should be used.

Parameter		Symbol	Ratings	Unit	
Diode	Forward Current (DC)		١F	50	mA
	Reverse Voltage		VR	5.0	V
	Power Dissipation		PD	50	mW
	Peak Forward Curre	ent <sup>*1</sup>	IFP	1	А
MOS FET	Break Down Voltage		VL	400	V
	Continuous	Connection A	١L	200	mA
	Load Current *2	Connection B		250	
		Connection C		400	
	Pulse Load Current <sup>*3</sup> (AC/DC Connection)		Ilp	400	mA
	Power Dissipation		P⊳	560	mW
Isolation Voltage *4		BV	1 500	Vr.m.s.	
Total Power Dissipation		Ρτ	610	mW	
Operating Ambient Temperature		TA	-40 to +85	°C	
Storage Temperature		Tstg	-40 to +100	°C	

## ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C, unless otherwise specified)

\*1 PW = 100 *µ*s, Duty Cycle = 1%

\*2 Conditions: IF  $\geq$  2 mA. The following types of load connections are available.



\*3 PW = 100 ms, 1 shot

\*4 AC voltage for 1 minute at  $T_A = 25^{\circ}$ C, RH = 60% between input and output. Pins 1-3 shorted together, 4-6 shorted together.

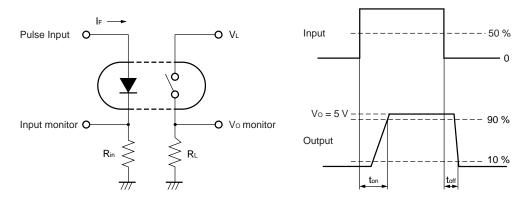
## **RECOMMENDED OPERATING CONDITIONS (TA = 25°C)**

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lf	2	10	20	mA
LED Off Voltage	VF	0		0.5	V

## ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C)

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	Ir	V <sub>R</sub> = 5 V			5.0	μA
MOS FET	Off-state Leakage Current	ILoff	V <sub>D</sub> = 400 V		0.03	1.0	μA
	Output Capacitance	Cout	V <sub>D</sub> = 0 V, f = 1 MHz		225		pF
Coupled	LED On-state Current	IFon	I∟ = 200 mA			2.0	mA
	On-state Resistance	Ron1	I⊧ = 10 mA, I∟ = 10 mA		6.0	10	Ω
		Ron2	$I_{\text{F}}$ = 10 mA, $I_{\text{L}}$ = 200 mA, $t \leq$ 10 ms				
	Turn-on Time *1, 2	ton	IF = 10 mA, Vo = 5 V, RL = 500 Ω,		0.8	5.0	ms
	Turn-off Time *1, 2	toff	PW ≥ 10 ms		0.02	0.2	
	Isolation Resistance	<b>R</b> ⊦o	VI-O = 1.0 kVDC	10 <sup>9</sup>			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1 MHz		1.1		pF

\*1 Test Circuit for Switching Time



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\*2 The turn-on time and turn-off time are specified as input-pulse width ≥ 10 ms.
 Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.

75<sup>85</sup>

f = 1 MHz

100

I⊧ = 10 mA

1.0

1.5

120

100

25

40

60

Applied Voltage VD (V)

300

200

100

-100

-200

-300

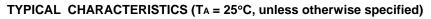
Load Voltage VL (V)

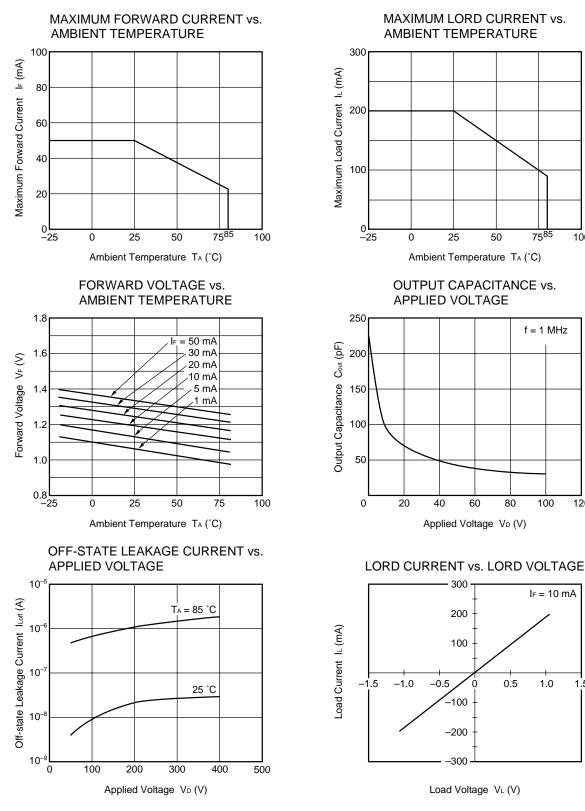
-0.5

80

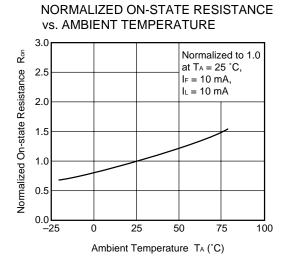
0.5

50

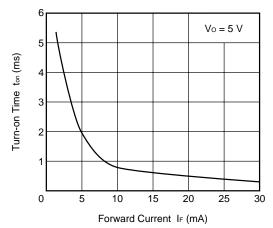




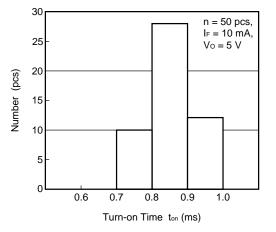
Remark The graphs indicate nominal characteristics.



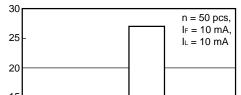
#### TURN-ON TIME vs. FORWARD CURRENT



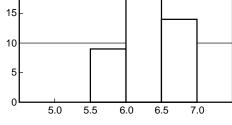
#### TURN-ON TIME DISTRIBUTION



Remark The graphs indicate nominal characteristics.



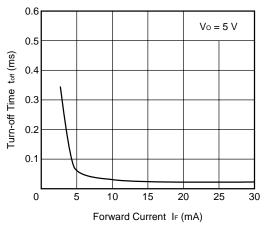
**ON-STATE RESISTANCE DISTRIBUTION** 



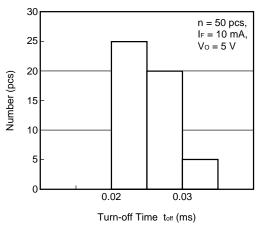
Number (pcs)

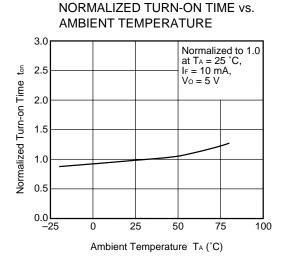
On-state Resistance  $R_{on}$  ( $\Omega$ )

#### TURN-OFF TIME vs. FORWARD CURRENT

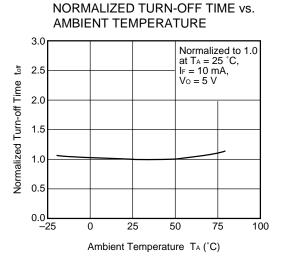


#### TURN-OFF TIME DISTRIBUTION

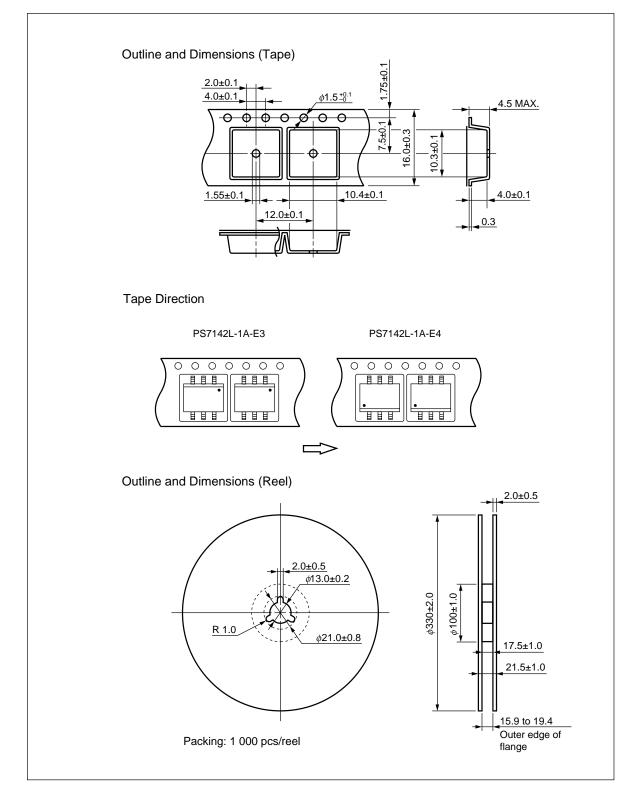




**Remark** The graphs indicate nominal characteristics.



## **TAPING SPECIFICATIONS (in millimeters)**



#### **RECOMMENDED SOLDERING CONDITIONS**

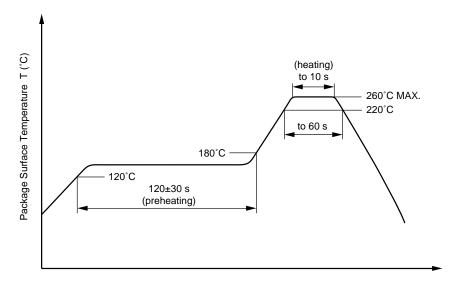
## (1) Infrared reflow soldering

- Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

## 260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

#### Recommended Temperature Profile of Infrared Reflow



Time (s)

#### (2) Wave soldering

<ul> <li>Temperature</li> </ul>	260°C or below (molten solder temperature)
• Time	10 seconds or less
<ul> <li>Preheating conditions</li> </ul>	120°C or below (package surface temperature)
<ul> <li>Number of times</li> </ul>	One
• Flux	Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

#### <R> (3) Soldering by soldering iron

<ul> <li>Peak temperature (lead part temperature)</li> </ul>	350°C or below
Time (each pins)	3 seconds or less
• Flux	Rosin flux containing small amount of chlorine (The flux with a
	maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

content of 0.2 Wt% is recommended.)

(b) Please be sure that the temperature of the package would not be heated over  $100^{\circ}$ C.

### (4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

## <R> USAGE CAUTIONS

- **1.** Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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M8E 02.11-1

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	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	<ol> <li>Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.</li> </ol>
	<ol><li>Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.</li></ol>
	• Do not burn, destroy, cut, crush, or chemically dissolve the product.
	• Do not lick the product or in any way allow it to enter the mouth.

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